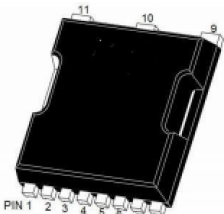
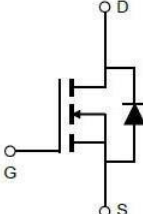




<p>General Description</p> <ul style="list-style-type: none"> ● Trench Power SGT technology ● Very low on-resistance $R_{DS(ON)}$ ● Low Gate Charge ● Excellent Gate Charge x $R_{DS(ON)}$ Product <p>Applications</p> <ul style="list-style-type: none"> ● High Frequency Switching and Synchronous Rectification 	<p>Product Summary</p> <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 60%;">V_{DS}</td> <td style="text-align: right;">40V</td> </tr> <tr> <td>I_D (at $V_{GS}=10V$)</td> <td style="text-align: right;">220A</td> </tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=10V$)</td> <td style="text-align: right;">0.78 mΩ</td> </tr> </table> <p>100% DVDS Tested 100% UIS Tested</p> <div style="text-align: right; border: 1px solid green; border-radius: 50%; padding: 5px; display: inline-block;">RoHS</div>	V_{DS}	40V	I_D (at $V_{GS}=10V$)	220A	$R_{DS(ON)}$ (at $V_{GS}=10V$)	0.78 m Ω
V_{DS}	40V						
I_D (at $V_{GS}=10V$)	220A						
$R_{DS(ON)}$ (at $V_{GS}=10V$)	0.78 m Ω						

Toll





Part Number	Package Type	Form	Marking
PW4022L	TOLL	Reel	PW4022L

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_C = 25^\circ C$	220
		$T_C = 100^\circ C$	120
Pulsed Drain Current A	I_{DM}	520	A
Avalanche Current A	I_{AS}	50	A
Single Pulse Avalanche Energy $L = 0.5mH^B$	E_{AS}	720	mJ
Power Dissipation $T_C = 25^\circ C$ -Derating factor	P_D	$T_C = 25^\circ C$	240
		-Derating factor	2
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Case	$R_{\theta JC}$	1.0	$^\circ C/W$
Maximum Junction-to-Ambient	$R_{\theta JA}$	50	



Electrical Characteristics($T_J=25^{\circ}\text{C}$ unless otherwise noted)						
Symbol	Parameter	Conditions	Value			Units
			Min	Typ	Max	
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=40\text{V}, V_{GS}=0\text{V}$	$T_J=25^{\circ}\text{C}$		1	μA
			$T_J=125^{\circ}\text{C}$		100	
I_{GSS}	Gate-Body Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0	1.7	2.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$		0.78	0.9	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=10\text{V}, I_D=10\text{A}$		60		S
V_{SD}	Diode Forward Voltage	$I_S=20\text{A}, V_{GS}=0\text{V}$			1.2	V
I_S	Maximum Body-Diode Continuous Current				120	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=20\text{V}, f=1\text{MHz}$		5332		pF
C_{oss}	Output Capacitance			2120		
C_{rss}	Reverse Transfer Capacitance			92		
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=20\text{V}, I_D=65\text{A}$		84		nC
Q_{gs}	Gate Source Charge			30		
Q_{gd}	Gate Drain Charge			17		
$t_{D(on)}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=90\text{A}, R_G=1.6\Omega$		12		ns
t_r	Turn-On Rise Time			48		
$T_{D(off)}$	Turn-Off Delay Time			24		
t_f	Turn-Off Fall Time			9.2		
t_{rr}	Body Diode Reverse Recovery Time	$I_F=60\text{A}, di/dt=100\text{A}/\mu\text{s}$		24		ns
Q_{rr}	Body Diode Reverse Recovery Charge			44		nC

- A. Single pulse width limited by maximum junction temperature.
- B. $T_J=25^{\circ}\text{C}, V_{DD}=25\text{V}, V_G=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$
- C. The power dissipation P_D is based on $T_{J(MAX)}=150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

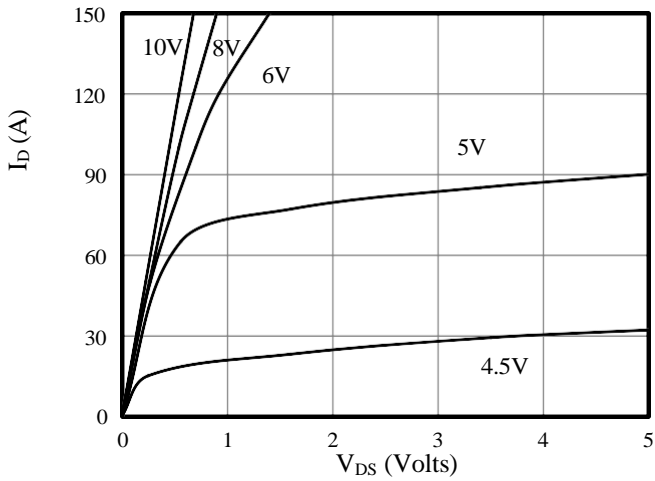


Figure 1: On-Region Characteristics

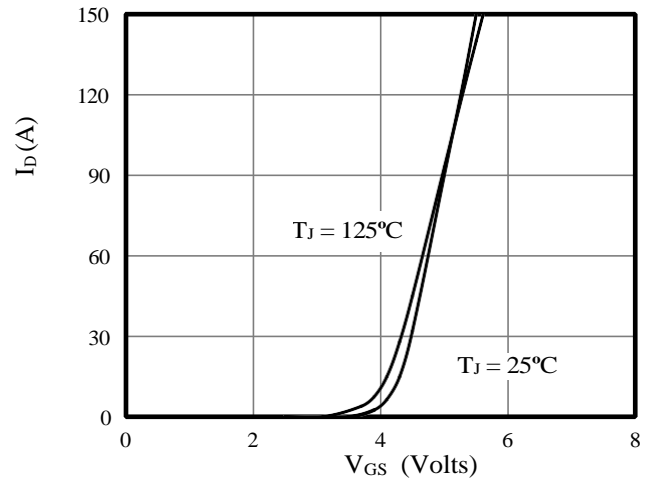


Figure 2: Transfer Characteristics

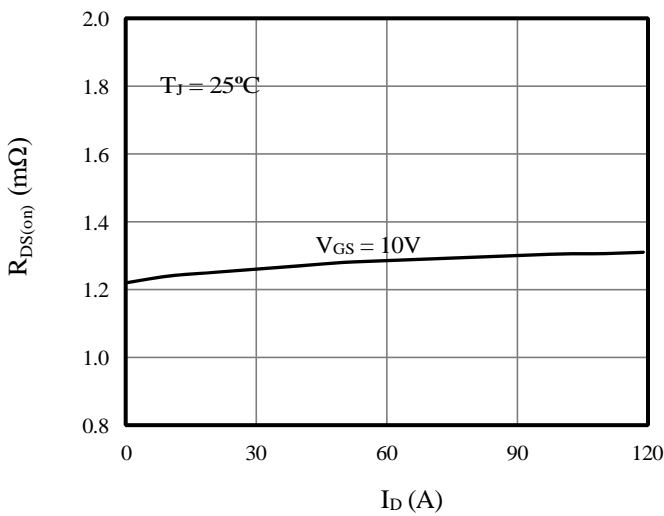


Figure 3: On-Resistance vs. Drain Current

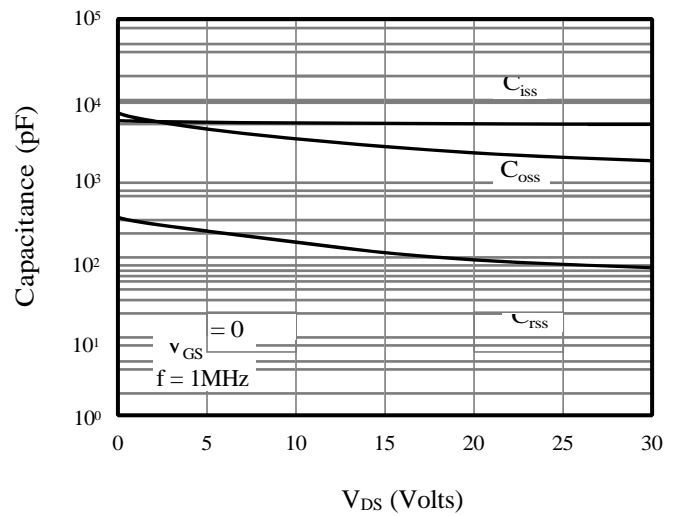


Figure 4: Capacitance Characteristics

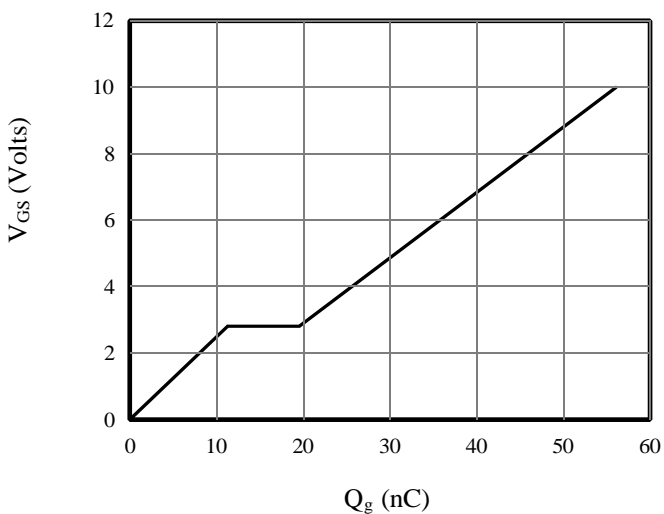


Figure 5: Gate Charge Characteristics

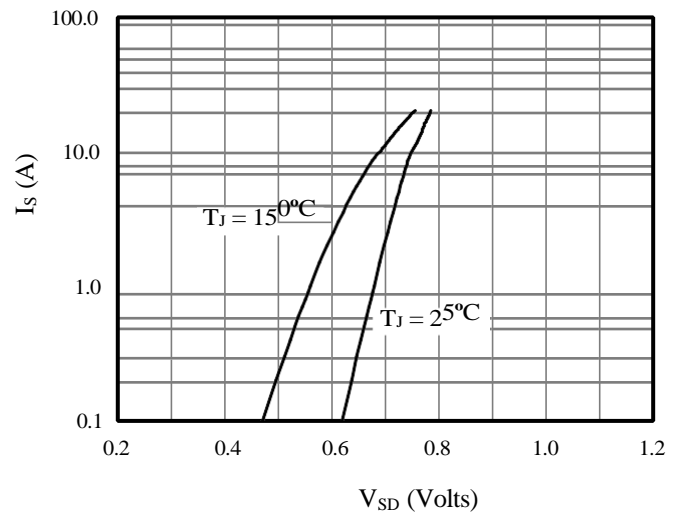


Figure 6: Body Diode Forward Voltage

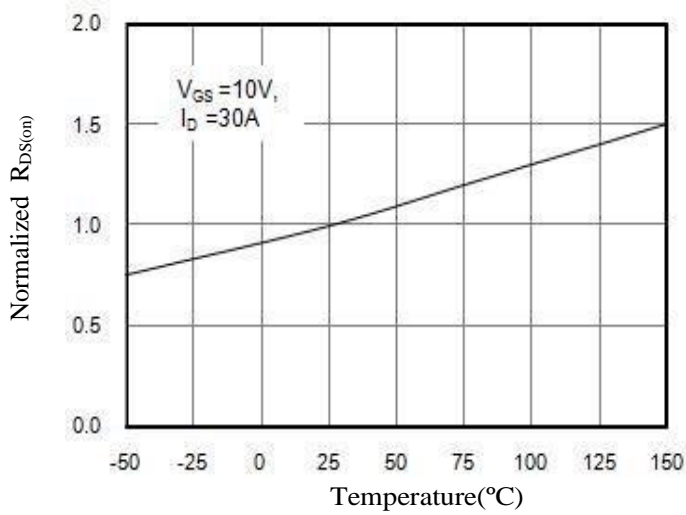


Figure 7: On-Resistance vs. Junction Temperature

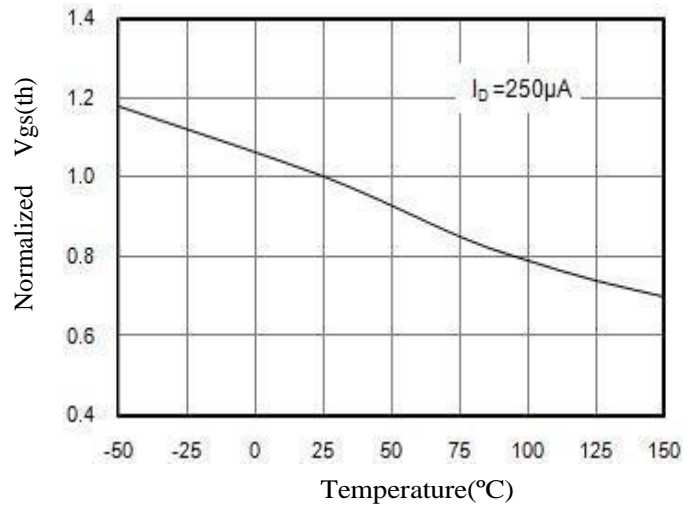


Figure 8: $V_{GS(th)}$ vs. Junction Temperature

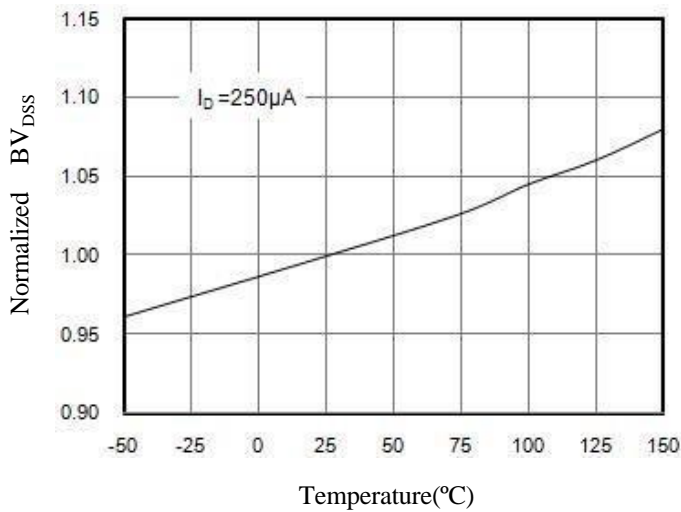


Figure 9: BV_{DS} vs. Junction Temperature

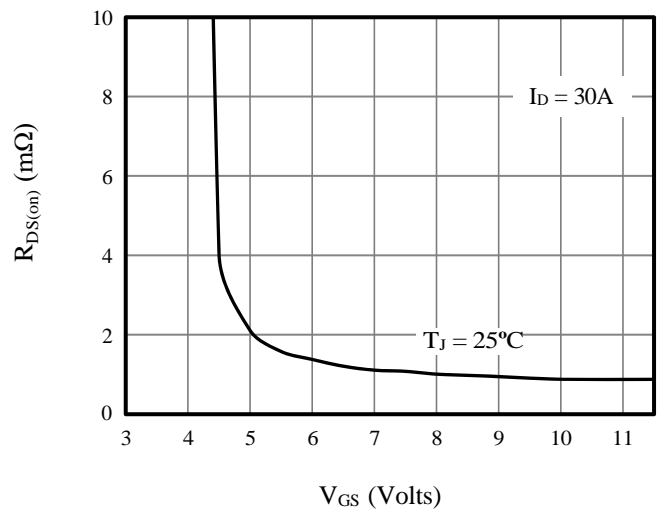


Figure 10: On-Resistance vs. Gate-Source Voltage



Figure A: Gate Charge Test Circuit and Waveforms

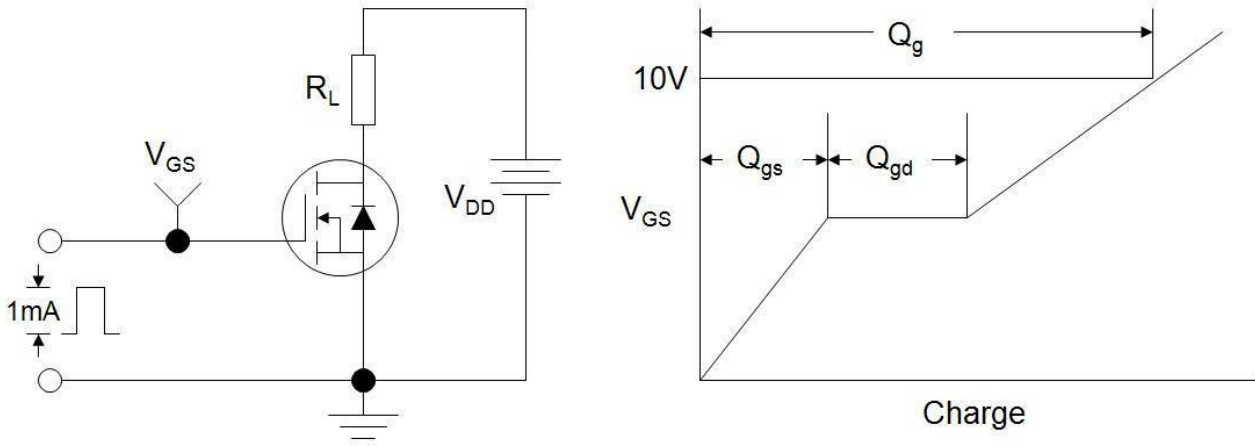


Figure B: Resistive Switching Test Circuit and Waveforms

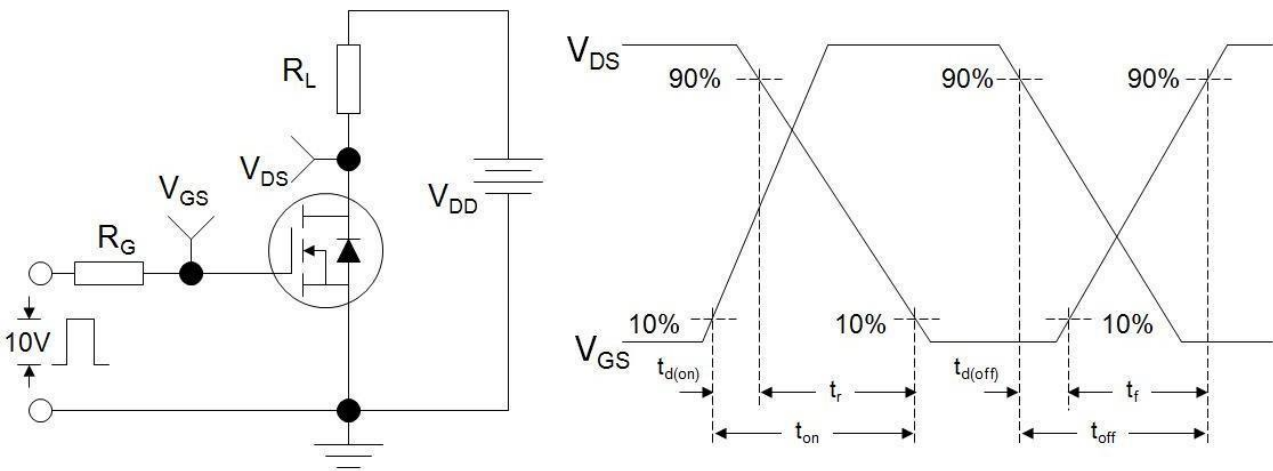
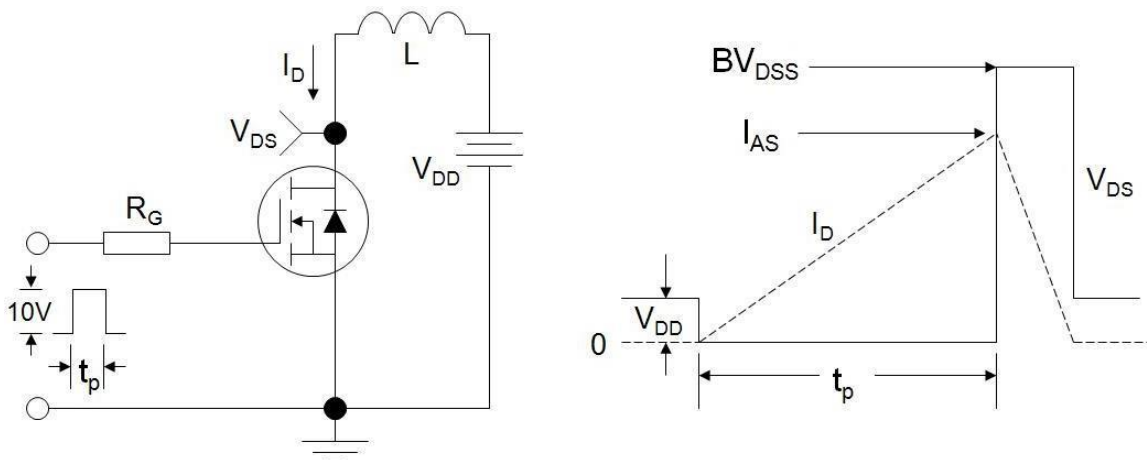
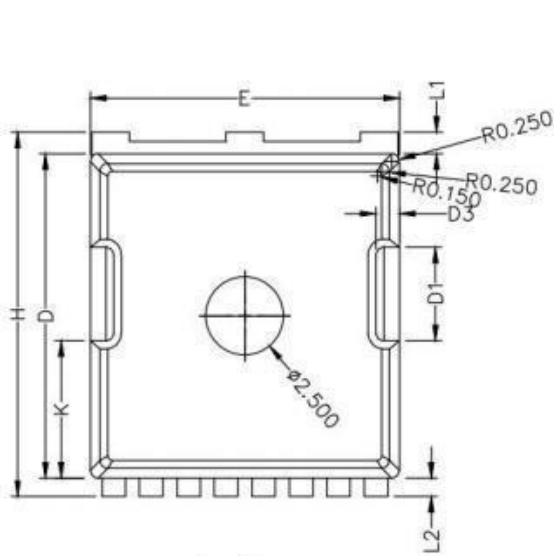


Figure C: Unclamped Inductive Switching (UIS) Test Circuit and Waveforms

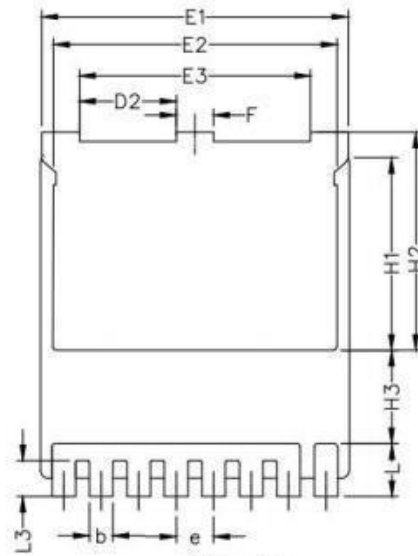




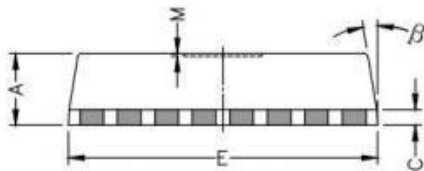
TOLL



Top View



Bottom View



Symbols	Millimeters		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
D2	2.95	3.10	3.25
D3	0.75 REF		
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.70	0.85
L2	0.45	0.60	0.75
L3	1.00	1.15	1.30
M	0.08 REF		
β	8°	10°	12°
K	4.25	4.40	4.55